



DMC4050SSD

D2

40V COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

			I _D Max	
Device	V _{(BR)DSS}	R _{DS(ON)} Max	$T_A = +25^{\circ}C$	
			(Notes 6 & 8)	
Q1	40V	45mΩ @ V _{GS} = 10V	5.5A	
Qi	40 V	60mΩ @ V _{GS} = 4.5V	4.2A	
Q2	40\/	45mΩ @ V _{GS} = -10V	-5.8A	
	-40V	60mΩ @ V _{GS} = -4.5V	-4.2A	

Description and Applications

This MOSFET is designed to ensure that $R_{DS(ON)}$ of N and P channel FET are matched to minimize losses in both arms of the bridge. The DMC4040SSD is optimized for use in 3-phase brushless DC motor circuits (BLDC), and CCFL backlighting.

- 3-Phase BLDC Motor
- CCFL Backlighting

Features and Benefits

- Matched N & P R_{DS(ON)} Minimizes Power Losses
- Fast Switching Minimizes Switching Losses
- Dual Device Reduces PCB Area
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at
 - https://www.diodes.com/products/automotive/automotiveproducts/.
- This part is qualified to JEDEC standards (as referenced in AEC-Q) for High Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMC4055SSDQ)

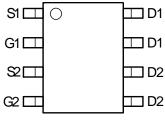
Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.074 grams (Approximate)

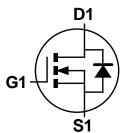
SO-8



Top View



Top View





G₂

Ordering Information (Note 4)

Product	Case	Packaging
DMC4050SSD-13	SO-8	2500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/guality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free. "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Marking Information



Oll = Manufacturer's Marking C4050SD = Product Type Marking Code YYWW = Date Code Marking YY or YY = Year (ex: 20 = 2020) WW = Week (01 - 53)

Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic			Symbol	N-Channel - Q1	P-Channel - Q2	Units
Drain-Source Voltage	Drain-Source Voltage			40	-40	V
Gate-Source Voltage			V _{GSS}	±20	±20	V
	V _{GS} = 10V	(Notes 6 & 8)	lο	5.8	-5.8	A
Continuous Drain Current		T _A = +70°C (Notes 6 & 8)		4.38	-4.52	
		(Notes 5 & 8)		4.2	-4.2	
		(Notes 5 & 9)		5.3	-5.3	
Pulsed Drain Current	$V_{GS} = 10V$	(Notes 7 & 8)	I_{DM}	24.1	-24.9	
Continuous Source Current (Body Diode) (Notes 6 & 8		(Notes 6 & 8)	Is	2.5	-2.5	
Pulsed Source Current (Body Diode) (Notes 7 & 8)		(Notes 7 & 8)	I _{SM}	24.1	-24.9	

Thermal Characteristics

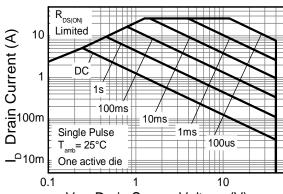
Characteristic	Symbol	Value	Unit		
Power Dissipation	(Notes 5 & 8)		1.25	W mW/°C	
Linear Derating Factor	(Notes 5 & 9)	PD	1.8		
	(Notes 6 & 8)		2.14		
	(Notes 5 & 8)		100		
Thermal Resistance, Junction to Ambient	(Notes 5 & 9)	R _{θJA}	70	00444	
	(Notes 6 & 8)		58	°C/W	
Thermal Resistance, Junction to Lead	(Notes 5 & 10)	R _{0JL}	51		
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C		

Notes:

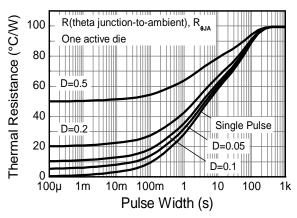
- 5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 6. Same as note (5), except the device is measured at $t \leq 10 \mbox{ sec.}$
- 7. Same as note (5), except the device is pulsed with D = 0.02 and pulse width $300\mu s$.
- 8. For a dual device with one active die.
- 9. For a device with two active die running at equal power.
- 10. Thermal resistance from junction to solder-point (at the end of the drain lead).



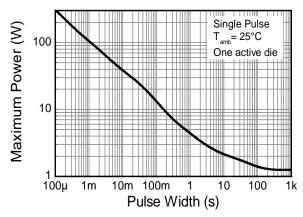
Thermal Characteristics (continued)



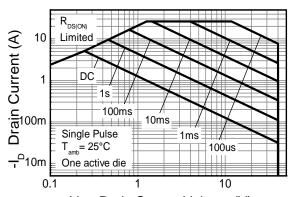
V_{DS} Drain-Source Voltage (V) **N-channel Safe Operating Area**



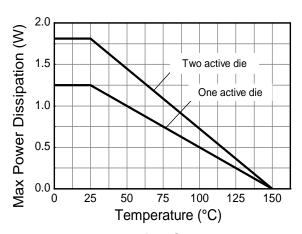
Transient Thermal Impedance



Pulse Power Dissipation



-V_{DS} Drain-Source Voltage (V) **P-channel Safe Operating Area**



Derating Curve



Electrical Characteristics (Q1 N-Channel) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 11)							
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	l		1.0	μΑ	$V_{DS} = 40V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	l	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 11)							
Gate Threshold Voltage	V _{GS(th)}	8.0	1.3	1.8	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D-avava		20	45	mΩ	$V_{GS} = 10V, I_D = 3A$	
Static Drain-Source on-Resistance	R _{DS(ON)}		33	60		$V_{GS} = 4.5V, I_D = 3A$	
Forward Transfer Admittance	Y _{fs}	1	12.6	_	S	$V_{DS} = 5V, I_{D} = 3A$	
Diode Forward Voltage (Note 11)	V_{SD}		0.7	1.0	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 12)							
Input Capacitance	C _{iss}	1	1790.8	_	pF	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Output Capacitance	Coss	l	160.6		pF	$V_{DS} = 20V, V_{GS} = 0V,$ -f = 1.0MHz	
Reverse Transfer Capacitance	C_{rss}		120.5	_	pF	71 = 1.0IVIH2	
Gate Resistance	R_g		1.03	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q_{g}	_	37.56	_	nC	101/11/ 001/	
Gate-Source Charge	Q_{gs}	_	7.8	_	nC	$V_{GS} = 10V, V_{DS} = 20V,$ $I_{D} = 3A$	
Gate-Drain Charge	Q_{gd}	_	6.6	_	nC		
Turn-On Delay Time	t _{D(on)}	_	8.08	_	nS		
Turn-On Rise Time	t _r	_	15.14	_	nS	V _{GS} = 10V, V _{DS} = 20V,	
Turn-Off Delay Time	t _{D(off)}	_	24.29	_	nS	$I_D = 3A$	
Turn-Off Fall Time	t _f		5.27	_	nS		

Electrical Characteristics (Q2 P-Channel) (@T_A = +25°C, unless otherwise specified.)

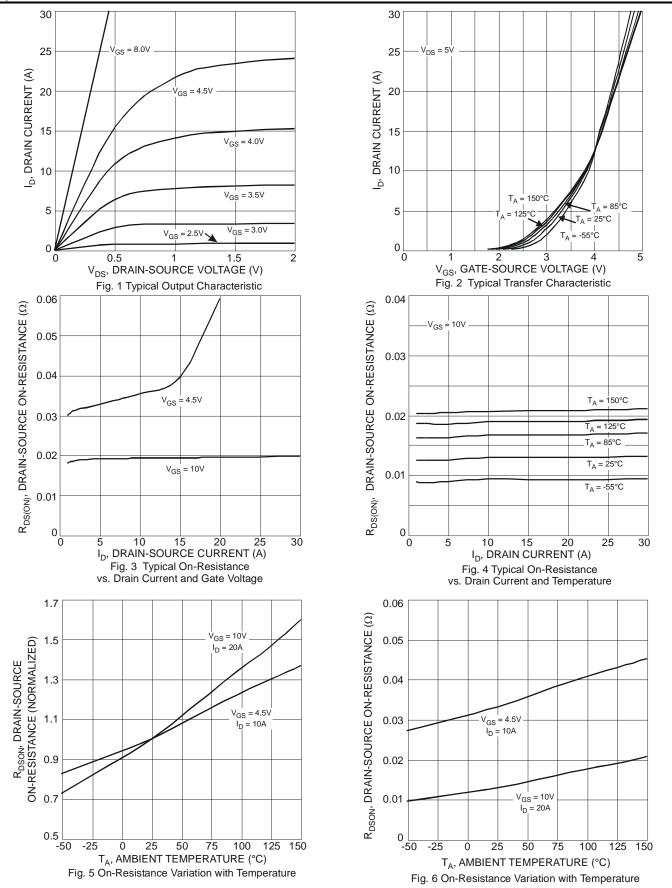
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 11)							
Drain-Source Breakdown Voltage	BV _{DSS}	-40	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	1	_	-1.0	μΑ	V _{DS} = -40V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 11)							
Gate Threshold Voltage	V _{GS(th)}	-0.8	-1.3	-1.8	٧	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance			28	45 60	mΩ	$V_{GS} = -10V, I_D = -3A$	
Static Dialii-Source Oil-Resistance	R _{DS(ON)}	_	30			$V_{GS} = -4.5V, I_{D} = -3A$	
Forward Transfer Admittance	Y _{fs}	1	16.6	_	S	$V_{DS} = -5V, I_{D} = -3A$	
Diode Forward Voltage (Note 11)	V_{SD}	1	-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 12)							
Input Capacitance	C _{iss}	1	1643.17		рF	N 00 V V 0 0 V	
Output Capacitance	C _{oss}	l	179.13	l	рF	$V_{DS} = -20V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	1	127.82	-	pF	1 = 1.0WHZ	
Gate Resistance	Rg	1	6.43	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	1	33.66	-	nC	10)/)/ 20)/	
Gate-Source Charge	Q _{gs}	_	5.54	_	nC	$V_{GS} = -10V, V_{DS} = -20V,$	
Gate-Drain Charge	Q _{gd}		7.30	_	nC	$I_D = -3A$	
Turn-On Delay Time	t _{D(on)}	_	6.85	_	nS		
Turn-On Rise Time	t _r		14.72	_	nS	$V_{GS} = -10V, V_{DS} = -20V,$	
Turn-Off Delay Time	t _{D(off)}	_	53.65	_	nS	$I_D = -3A$	
Turn-Off Fall Time	t _f	_	30.86	_	nS		

Notes:

^{11.} Short duration pulse test used to minimize self-heating effect.12. Guaranteed by design. Not subject to production testing.



Typical Characteristics (Q1 N-Channel)







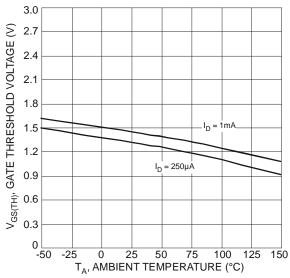
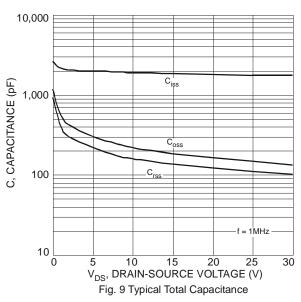
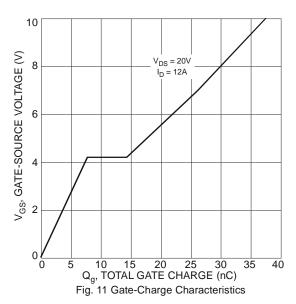
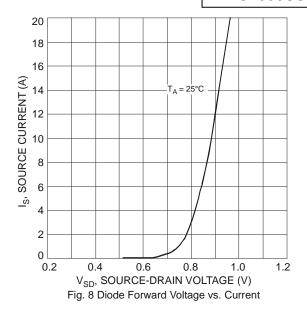
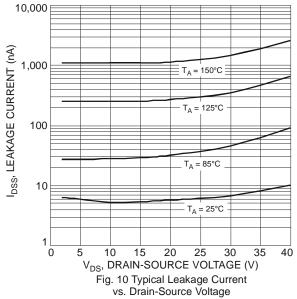


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

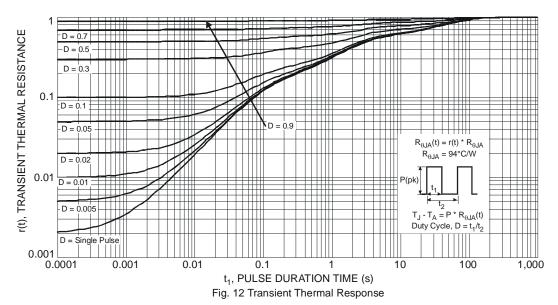






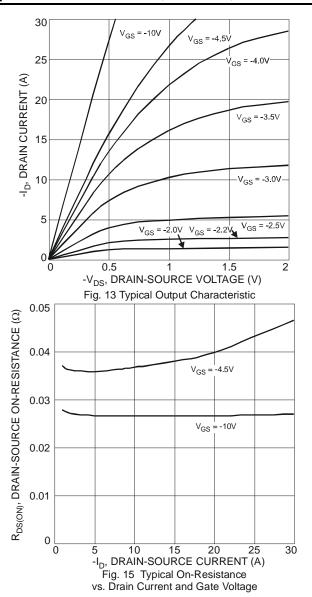


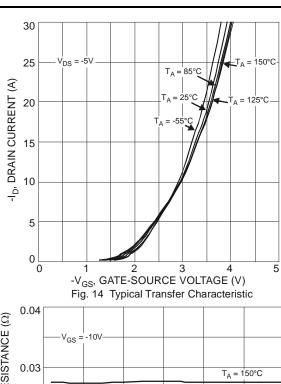






Typical Characteristics (Q2 P-Channel)





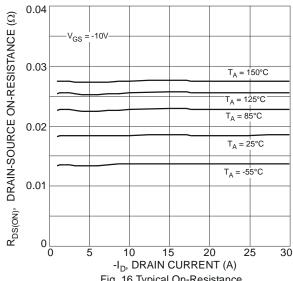
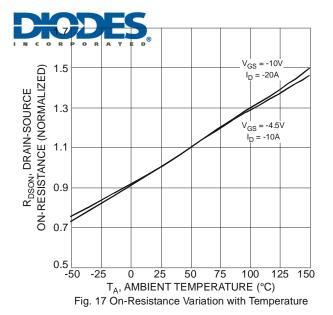
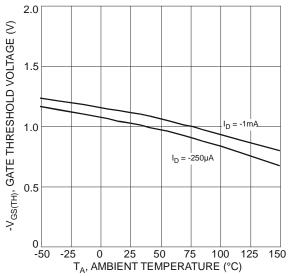


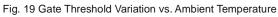
Fig. 16 Typical On-Resistance vs. Drain Current and Temperature

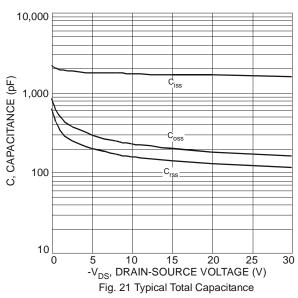


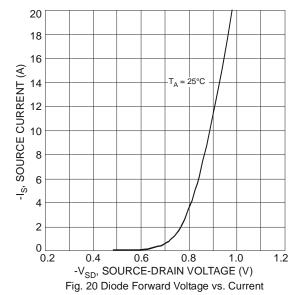
0.06 **DMC4050SSD** R_{DSON} , DRAIN-SOURCE ON-RESISTANCE (Ω) 0.05 0.04 0.03 .V_{GS} : I_D = -10A 0.02 $V_{GS}^{'} = -10^{1}$ V $I_{D} = -20A$ 0.01 -50 25 50 75 100 125 150 T_A, AMBIENT TEMPERATURE (°C)

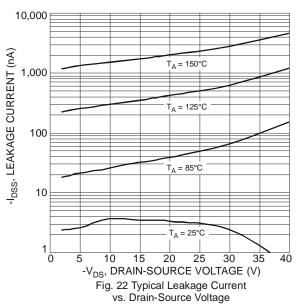
Fig. 18 On-Resistance Variation with Temperature

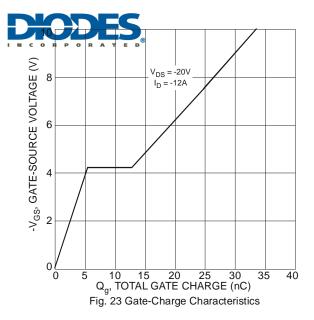


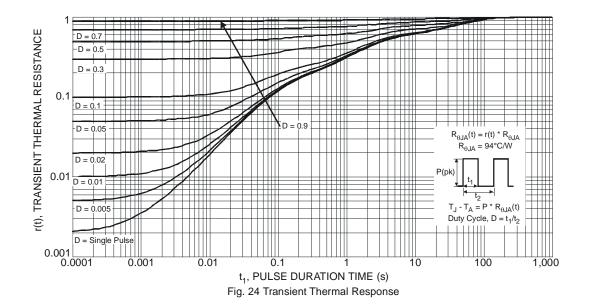








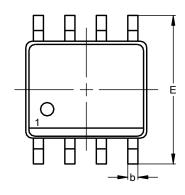


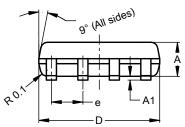


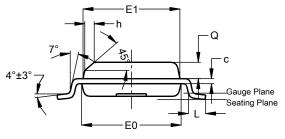


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.







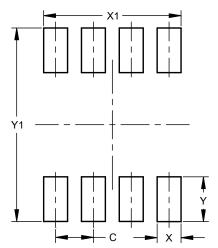
SO-8

SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A1	0.10	0.20	0.15			
b	0.30	0.50	0.40			
C	0.15	0.25	0.20			
D	4.85 4.95 4.90		4.90			
Е	5.90 6.10		6.00			
E1	3.80	3.90	3.85			
E0	E0 3.85 3.95 3.90					
е	e 1.27					
h	h 0.35					
Г	0.62	0.82	0.72			
Ø	0.60	0.70	0.65			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
С	1.27
X	0.802
X1	4.612
Y	1.505
Y1	6.50



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